

PRM7R3N06CT

PFC Device Corporation

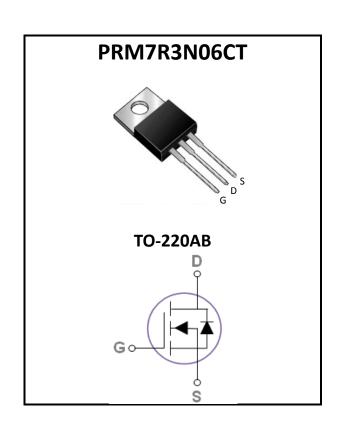
60V Single N-Channel MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V_{DS}	60	٧
$I_{D}^{5} (T_{C}=25^{\circ}C)$	134	Α
Max. R _{DS(ON)} @V _{GS} =10V	7.3	mΩ
Max. R _{DS(ON)} @V _{GS} =4.5V	10.7	mΩ
T _J Operating Junction Temperature	-55 to +150	°C

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.



Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting

Features

- Max. $R_{DS(ON)}=7.3m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

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1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D^{5}	Drain Current – Continuous (T _C =25°C)	134	Α
ID	Drain Current – Continuous (T _C =100°C)	84	Α
I_D^6	Drain Current – Continuous (T _C =25°C)	60	Α
I _{DM}	Drain Current – Pulsed ¹	240	Α
E _{AS}	Single Pulse Avalanche Energy ²	27	mJ
I _{AS}	Single Pulse Avalanche Current ²	23	Α
В	Power Dissipation (T _C =25°C)	208	W
P_D	Power Dissipation – Derate above 25°C	1.6	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		0.6	°C/W



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Electrical Characteristics

(T_J = 25 °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60			V
-	Durin Comment and a second	V _{DS} =60V, V _{GS} =0V, T _J =25°C			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =48V, V _{GS} =0V, T _J =100°C			100	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA

On Characteristics

D	Static Drain-Source	V _{GS} =10V, I _D =20A		6.1	7.3	mΩ
$R_{DS(ON)}$	On-Resistance	V _{GS} =4.5V, I _D =10A		8.8	10.7	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.8	2.5	V
g_{fs}	Forward Transconductance	V _{DS} =5V, I _D =10A		36	ł	S

Dynamic and switching Characteristics

Q _a	Total Gate Charge ^{3,4}		 27.6	
Q _{qs}	Gate-Source Charge ^{3, 4}	V _{DS} =30V, V _{GS} =10V, I _D =10A	 5.7	 nC
Q_{gd}	Gate-Drain Charge ^{3,4}		 4.7	
T _{d(on)}	Turn-On Delay Time ^{3,4}		 8	
Tr	Turn-On Rise Time ^{3, 4}	V_{DD} =30V, V_{GS} =10V, R_{G} =6 Ω	 19	 20
$T_{d(off)}$	Turn-Off Delay Time ^{3,4}		 32	 ns
T _f	Turn-Off Fall Time ^{3, 4}		 46	
C _{iss}	Input Capacitance		 1652	
C _{oss}	Output Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	 498	 pF
C _{rss}	Reverse Transfer Capacitance		 35	
R_{g}	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	 0.8	 Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$V_{GS}=0V$, $I_{S}=1A$	 	1.0	V
t _{rr}	Reverse Recovery Time	1 204 di/dt 1004/ug	 19		ns
Q_{rr}	Reverse Recovery Charge	I _S =20A, di/dt=100A/us	 7		nC

Note:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2. VDD=50V, VGS=10V, L=0.1mH, RG=25 Ω , Starting TJ=25 $^{\circ}$ C
- 3. The data tested by pulsed, pulse width ≤300us, duty cycle ≤2%.
- 4. Essentially independent of operating temperature.
- 5. Silicon limited
- 6. Package limited.



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2. Characteristics Curves

Ratings and Characteristics Curves

(T_A = 25° unless otherwise specified)

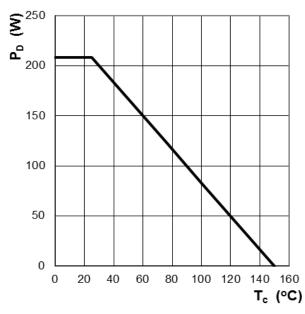


Figure 1: Power Dissipation

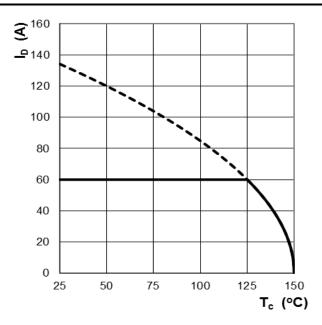


Figure 2: Continuous Drain Current vs. T_C

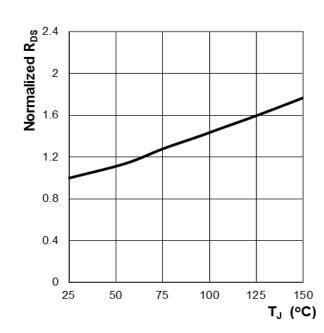


Figure 3: Normalized R_{DS(ON)} vs. T_J

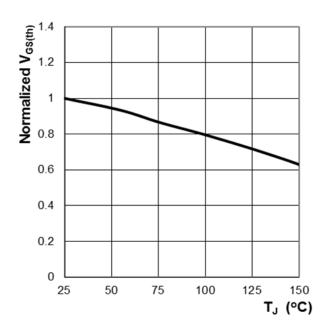


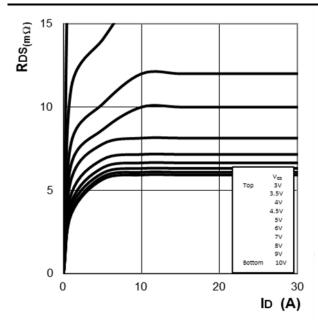
Figure 4: Normalized Vth vs. TJ



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Ratings and Characteristics Curves

(T_A = 25°C unless otherwise specified)



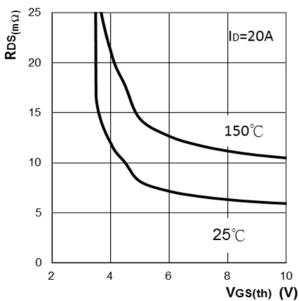


Figure 5: RDS(ON) vs. Drain Current and Gate Voltage

Figure 6: RDS(ON) vs. Gate Voltage

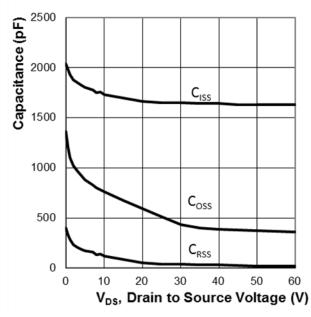


Figure 7: Typ. Capacitance Characteristics

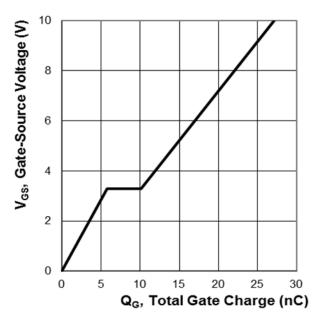


Figure 8: Typ. Gate Charge Characteristics



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Ratings and Characteristics Curves

($T_A = 25^{\circ}C$ unless otherwise specified)

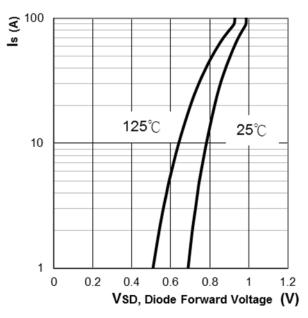


Figure 9: Body Diode Characters

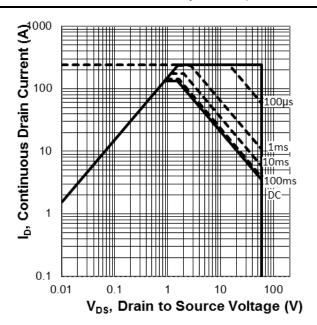


Figure 10: Maximum Safe Operation Area

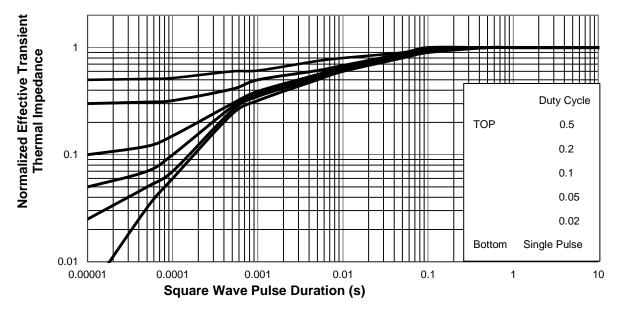


Figure 11: Normalized Thermal Transient Impedance, Junction-to-Case



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3. Marking information

Top Marking Rule

PFC PRM 7R3N06CT YYWW ABSH

PRM7R3N06CT = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

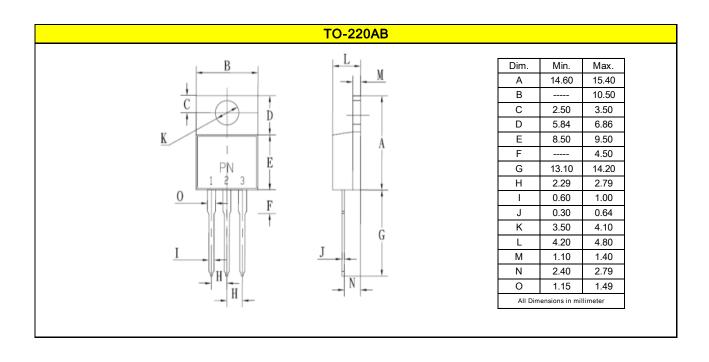
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters





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5. Ordering information

Part Number	Package	Delivery mode
PRM7R3N06CT	TO-220AB	50 pcs / Tube

Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
Device Weight: 0.07 ounces (1.96grams) - TO-220AB

Mounting Torque : Recommended 4~5 kg-cm

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